Docket No.: MR2863-155

COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **Heat Resistant Food Packing Material and Method of Manufacturing The Food Packing Material**

the specification of which (ch	neck one)			
(X) is attached hereto.				
		ation Serial No.	-	
and with amendment	s through	·		
		derstand the contents of the ment referred to above (if any)	above-identified specification,	
I acknowledge the duty to di accordance with Title 37, Co			mination of this application in	
foreign application listed be	elow and have a		Section 119 of the following eign application for patent or ch priority is claimed:	
EARLIEST FOREIGN A		S), IF ANY, FILED WITHIN S APPLICATION	I 12 MONTHS PRIOR TO	
Prior Foreign Application:				
	appl. No.	Filing Date	Priority Claimed <u>Yes/No</u>	
ALL FOREIGN APPLI	•	NY, FILED MORE THAN S APPLICATION	12 MONTHS PRIOR TO	
Country A	ppl. No.	Status		
		Patented/Pending/Abandoned		
prosecute this application and MORTON J. ROSENBERG	I transact all busin, ESQ., Reg. 26,0 L. SERNAKER, MORTON J. ROSENBERO 3458 ELLICO ELLICOTT C FAX #: 410-	ress in the Patent and Tradema (49; DAVID I. KLEIN, ESQ., ESQ., #50,595; DAVID ROSENBERG at telephone nu G, KLEIN & LEE DTT CENTER DRIVE-SUITE CITY, MD 21043	nmber 410-465-6678	

DECLARATION

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of inventor	Chi-Yee Yeh (Family Name is Yeh)
Inventor's signature	Gehllige.
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